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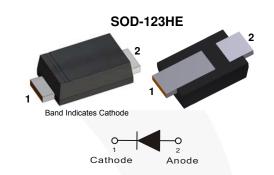


January 2016

# S1JFP - S1MFP 1.2 A, 600 V - 1000 V Surface Mount Rectifiers

#### **Features**

- · Low Power Loss, High Efficiency
- · Larger Cathode Pad for Improved Power Dissipation
- Ultra Thin Profile Package Height <1.0 mm
- High Surge Capacity
- · Low Forward Voltage: 1.3 V Maximum
- · UL Flammability 94V-0 Classification
- MSL 1 per J-STD-020
- · RoHS Compliant / Green Molding Compound
- · Industrial Device Qualified per AEC-Q101 Standards
  - \* See authorized use policy



# **Ordering Information**

| Part Number | Top Mark | Package   | Packing Method |
|-------------|----------|-----------|----------------|
| S1JFP       | 1JL      | SOD-123HE | Tape and Reel  |
| S1KFP       | 1KL      | SOD-123HE | Tape and Reel  |
| S1MFP       | 1ML      | SOD-123HE | Tape and Reel  |

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25$ °C unless otherwise noted.

| Symbol             | Parameter   | Value       |       |       | Unit |
|--------------------|---|-------------|-------|-------|------|
|                    | Faiailletei   | S1JFP       | S1KFP | S1MFP | Uill |
| $V_{RRM}$          | Repetitive Peak Reverse Voltage   | 600         | 800   | 1000  | V    |
| V <sub>RMS</sub>   | RMS Reverse Voltage   | 420         | 560   | 700   | V    |
| V <sub>R</sub>     | DC Blocking Voltage   | 600         | 800   | 1000  | V    |
| I <sub>F(AV)</sub> | Average Forward Rectified Current   | 1.2         |       | Α     |      |
| I <sub>FSM</sub>   | Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load | 50          |       | А     |      |
| T <sub>J</sub>     | Operating Junction Temperature Range  | -55 to +150 |       | °C    |      |
| T <sub>STG</sub>   | Storage Temperature Range   | -55 to +150 |       | °C    |      |

# Thermal Characteristics(1)

Values are at  $T_A$  = 25°C unless otherwise noted.

| Symbol          | Parameter  | Value | Unit |
|-----------------|--|-------|------|
| ΨJL             | Typical Thermal Characteristics, Junction-to-Lead <sup>(2)</sup> | 12    | °C/W |
| $R_{\theta JA}$ | Typical Thermal Resistance, Junction-to-Ambient                  | 140   | °C/W |

## Notes:

- 1. Per JESD51-3 recommended thermal test board. Device mounted on FR-4 PCB, board size = 76.2 mm x 114.3 mm.
- 2. Thermocouple soldered at cathode lead.

# **Electrical Characteristics**

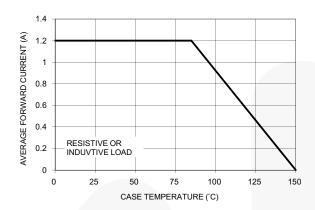
Values are at  $T_A = 25^{\circ}C$  unless otherwise noted.

| Symbol          | Parameter                                    | Conditions  | Min. | Тур. | Max. | Unit |
|-----------------|--|---|------|------|------|------|
| $V_{F}$         | Instantaneous Forward Voltage <sup>(3)</sup> | I <sub>F</sub> = 1.2 A  |      |      | 1.3  | ٧    |
| I <sub>R</sub>  | Reverse Current at Rated V <sub>R</sub>      | T <sub>J</sub> = 25°C   |      |      | 5    | μА   |
|                 |  | T <sub>J</sub> = 125°C  |      |      | 150  |      |
| CJ              | Junction Capacitance                         | V <sub>R</sub> = 0 V, f = 1 MHz   |      | 18   |      | pF   |
| T <sub>rr</sub> | Reverse Recovery Time                        | I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1 A,<br>I <sub>rr</sub> = 0.25 A |      | 1.5  |      | μs   |

#### Note:

3. Pulse test with PW = 300  $\mu$ s, 1% duty cycle

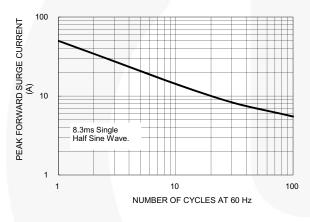
# **Typical Performance Characteristics**



100 T<sub>J</sub>=125°C CORBENT O.01 0.01 T<sub>J</sub>=25°C T<sub>J</sub>

Figure 1. Maximum Forward Current Derating Voltage

Figure 2. Typical Reverse Characteristics



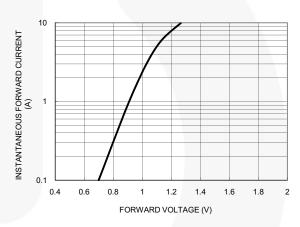
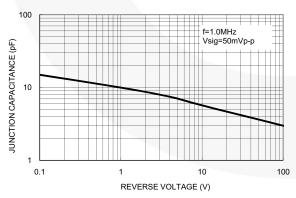


Figure 3. Maximum Non-Repetitive Forward Surge Current

Figure 4. Typical Instantaneous Forward Characteristics



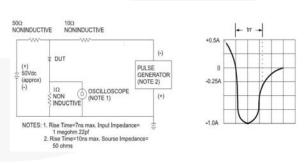
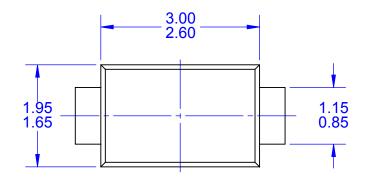
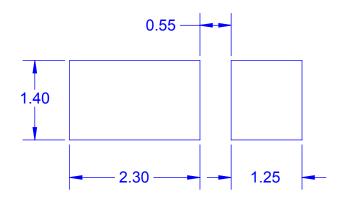
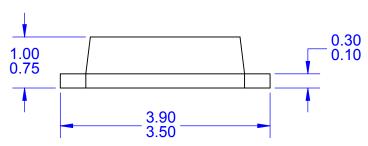


Figure 5. Typical Junction Capacitance

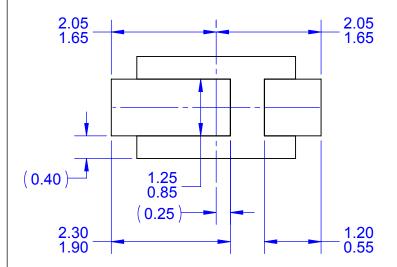
Figure 6. Reverse Recovery Time Characteristic and Test Circuit Diagram











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